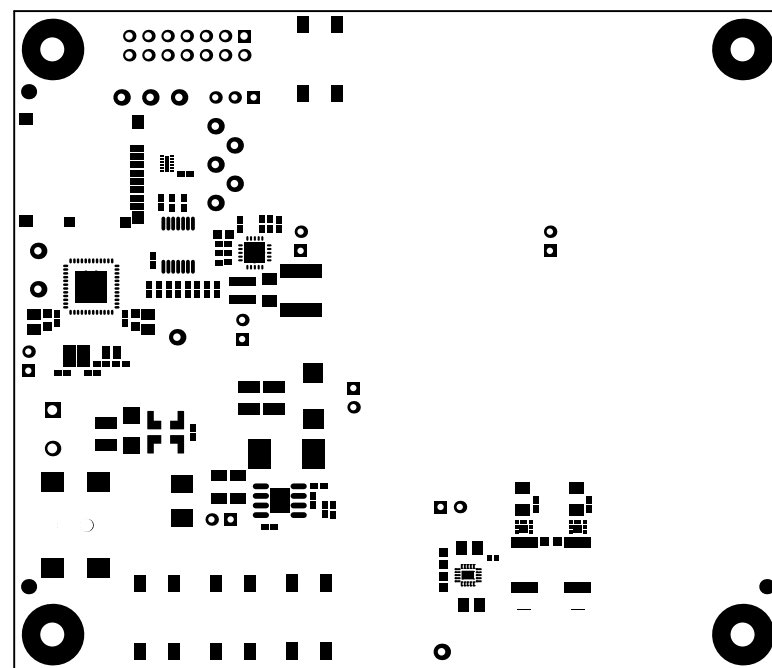
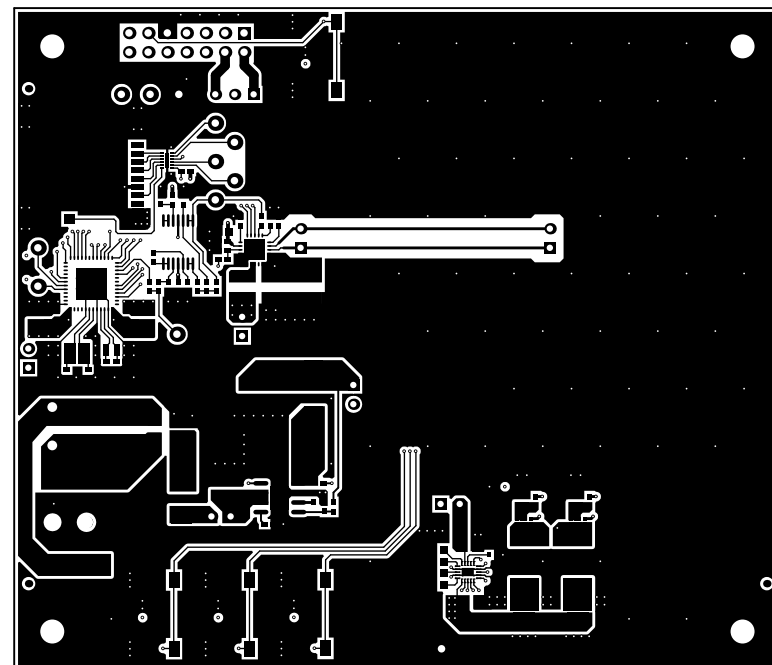


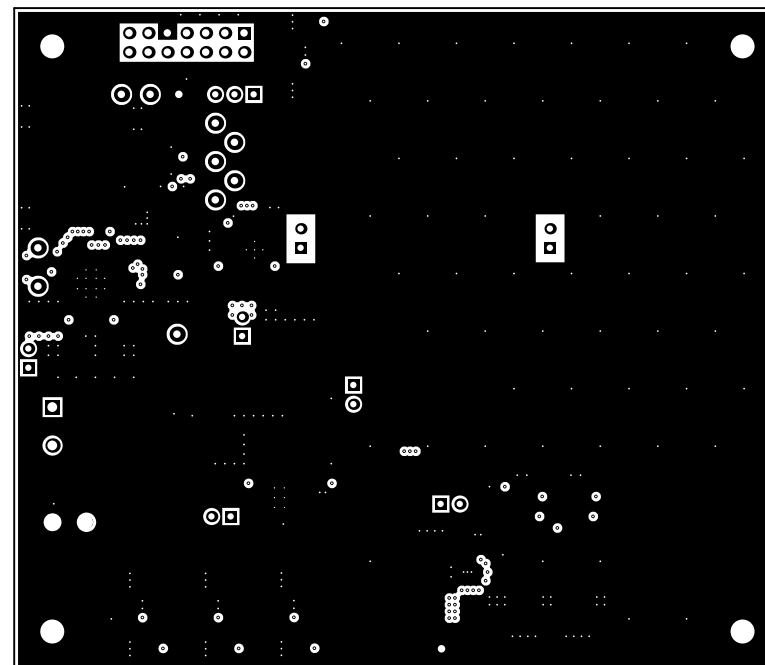
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: ISE4028	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Top Overlay	TID #: TIDA-00376		
PLOT NAME = Top Overlay	GENERATED : 6/4/2015	12:49:09 PM	TEXAS INSTRUMENTS



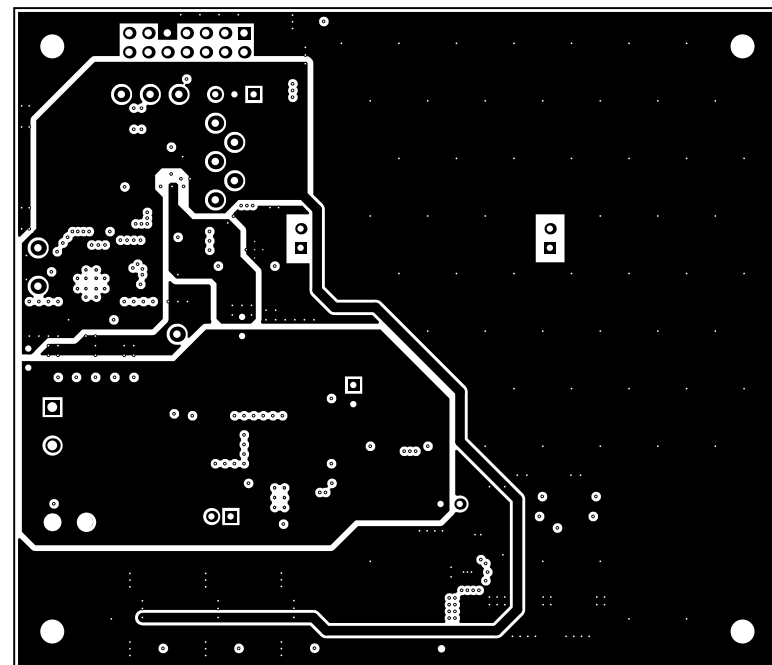
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: ISE4028	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Top Solder	TID #: TIDA-00376		
PLOT NAME = Top Solder Mask	GENERATED : 6/4/2015 12:49:10 PM	TEXAS INSTRUMENTS	



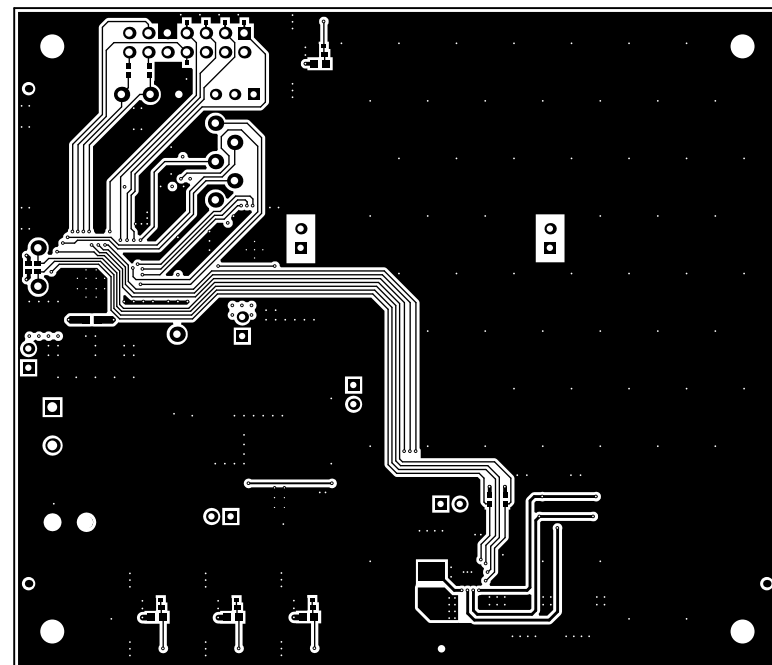
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: ISE4028	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Layer 1 - Top Layer	TID #: TIDA-00376		
PLOT NAME = Top Layer	GENERATED : 6/4/2015 12:49:11 PM	TEXAS INSTRUMENTS	



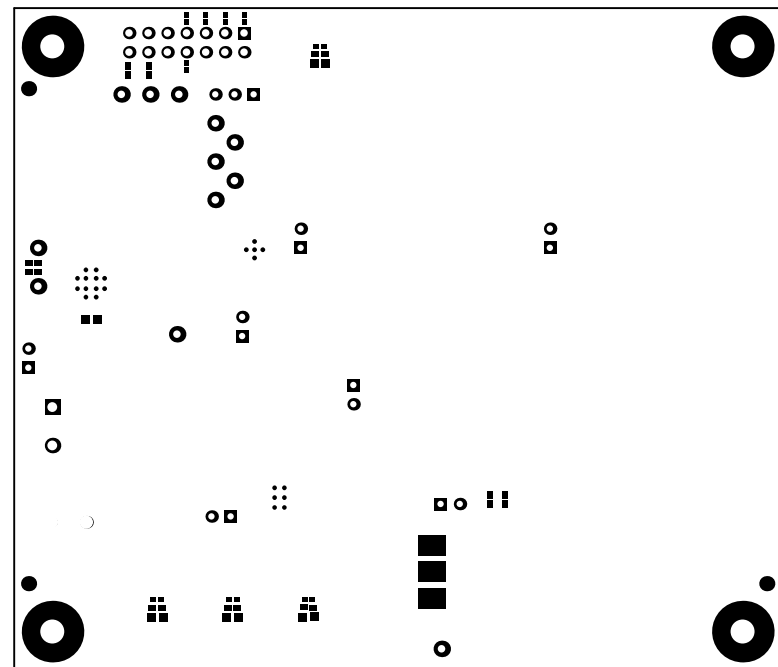
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: ISE4028	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Layer 2 - GND	TID #: TIDA-00376		
PLOT NAME = Signal Layer 1	GENERATED : 6/4/2015 12:49:13 PM	TEXAS INSTRUMENTS	



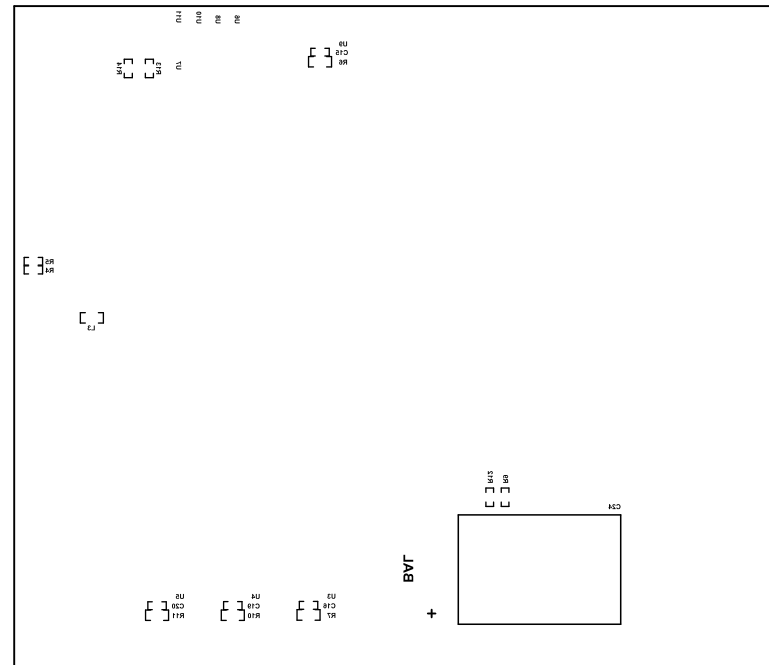
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: ISE4028	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Layer 3 - PWR	TID #: TIDA-00376		
PLOT NAME = Signal Layer 2	GENERATED : 6/4/2015 12:49:14 PM	TEXAS INSTRUMENTS	



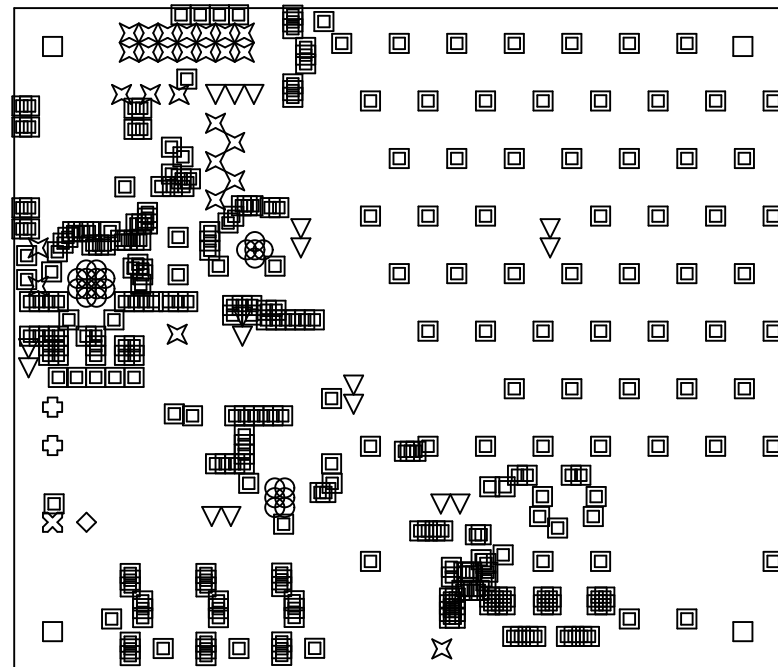
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: ISE4028	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Layer 4 - Bottom Layer	TID #: TIDA-00376		
PLOT NAME = Bottom Layer	GENERATED : 6/4/2015 12:49:15 PM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: ISE4028	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Bottom Solder	TID #: TIDA-00376		
PLOT NAME = Bottom Solder Mask	GENERATED : 6/4/2015 12:49:17 PM	TEXAS INSTRUMENTS	

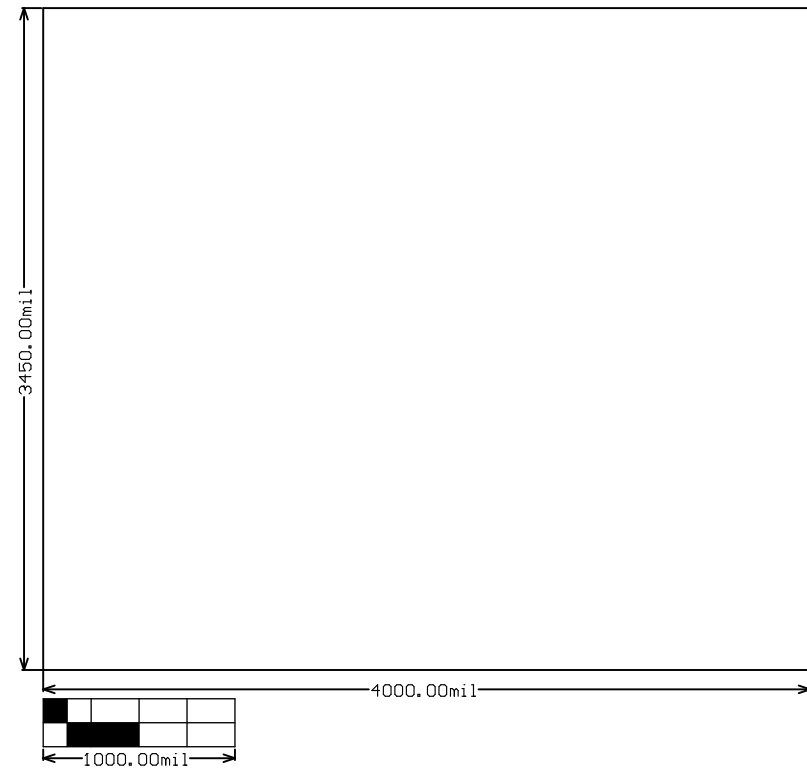


ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: ISE4028	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Bottom Overlay	TID #: TIDA-00376		
PLOT NAME = Bottom Overlay	GENERATED : 6/4/2015	12:49:18 PM	TEXAS INSTRUMENTS



Symbol	Quantity	Finished Hole Size	Plated	Hole Type
⊗	1	62.99mil (1.600mm)	NPTH	Round
◇	1	70.87mil (1.800mm)	NPTH	Round
○	23	7.87mil (0.200mm)	PTH	Round
■	305	10.00mil (0.254mm)	PTH	Round
▽	17	33.46mil (0.850mm)	PTH	Round
⊗	26	40.00mil (1.016mm)	PTH	Round
⊕	2	51.18mil (1.300mm)	PTH	Round
□	4	125.98mil (3.200mm)	PTH	Round
	379 Total			

ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: ISE4028	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Drill Drawing	TID #: TIDA-00376		
PLOT NAME = Drill Drawing	GENERATED : 6/4/2015	12:49:20 PM	TEXAS INSTRUMENTS



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: ISE4028	REV: E1	SVN REV: Not In VersionControl
LAYER NAME = M2 Board Dimensions	TID #: TIDA-00376		
PLOT NAME = Board Dimensions	GENERATED : 6/4/2015	12:49:21 PM	TEXAS INSTRUMENTS

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